

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Parameter	Rating	Units
Blocking Voltage	60	$V_{P}$
Load Current	750	mA
Load Current, Peak AC	1	A
On-Resistance (max)	0.6	Ω
LED Current to operate	2	mA

#### **Features**

Low On-Resistance: 0.6Ω
Low Drive Current: 2mA
High Load Current: 750mA
1500V<sub>rms</sub> Input/Output Isolation

100% Solid State

Compact 4-Pin SOP Package

· Arc-Free With No Snubbing Circuits

No EMI/RFI Generation

· Immune to Radiated EM Fields

Wave Solderable

• Tape & Reel Version Available

## **Applications**

Security

Passive Infrared Detectors (PIR)

Data Signalling

Sensor Circuitry

Instrumentation

Multiplexers

Data Acquisition

Electronic Switching

I/O Subsystems

Utility Meters (gas, oil, electric and water)

Medical Equipment—Patient/Equipment Isolation

Aerospace

Industrial Controls

ATE

## **Description**

CPC1019N is a miniature, low-voltage, low on-resistance, single-pole, normally-open (1-Form-A) solid state relay in a small 4-pin SOP package.

Embodying IXYS Integrated Circuits Division's patented OptoMOS technology, the CPC1019N comprises a highly efficient infrared LED that is optically coupled to efficient MOSFET output switches to provide  $1500V_{rms}$  of input-to-output isolation.

IXYS Integrated Circuits Division's state of the art double-molded vertical construction packaging produces a very compact solid state relay that is ideal for replacing larger, less-reliable reed and electromechanical relays.

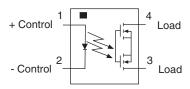
## **Approvals**

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1172007
- EN/IEC 60950-1 Certified Component: Certificate B 13 12 82667 003

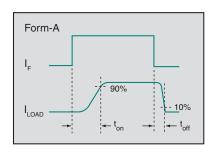
# **Ordering Information**

Part #	Description
CPC1019N	4-Pin SOP (100/tube)
CPC1019NTR	4-Pin SOP (2000/reel)

# **Pin Configuration**



# **Switching Characteristics** of Normally-Open Devices











# Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	60	V <sub>P</sub>
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	А
Input Power Dissipation	70	mW
Total Power Dissipation <sup>1</sup>	400	mW
Isolation Voltage, Input to Output	1500	$V_{\rm rms}$
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

<sup>1</sup> Derate linearly 3.33 mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Typical values are characteristic of the device at +25°C, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.

## Electrical Characteristics @ 25°C

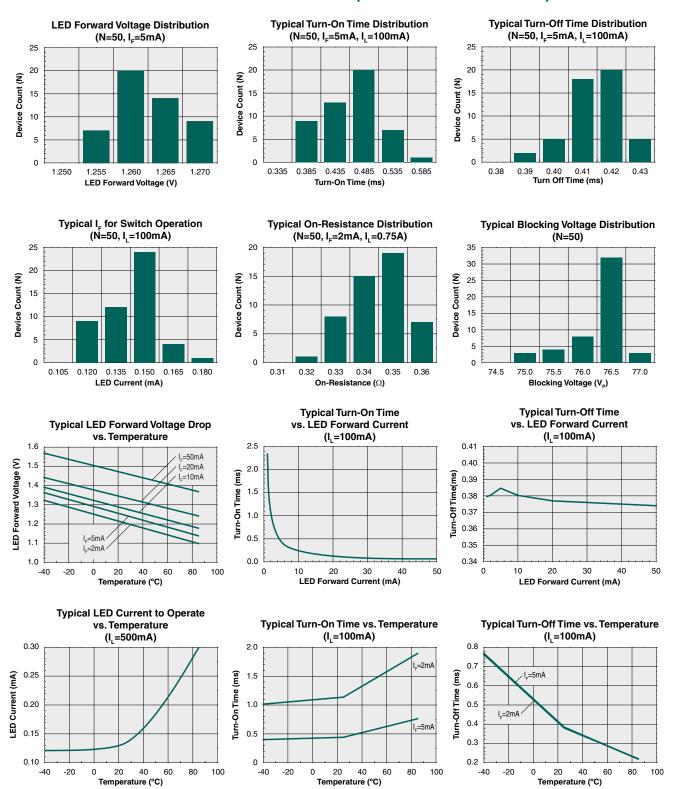
Parameter	Conditions	Symbol	Min	Тур	Max	Units
Output Characteristics						
Load Current						
Continuous	I 0m A	1	-	-	750	mA <sub>DC</sub>
Continuous, AC Peak	I <sub>F</sub> =2mA	'L	-	-	1	Α
Peak	t <u>&lt;</u> 10ms	I <sub>LPK</sub>	-	-	3	A <sub>P</sub>
On-Resistance <sup>1</sup>	I <sub>L</sub> =750mA	R <sub>ON</sub>	-	0.35	0.6	Ω
Off-State Leakage Current	$V_L = 60V_P$	I <sub>LEAK</sub>	-	-	1	μΑ
Switching Speeds						
Turn-On	I <sub>F</sub> =5mA, V <sub>L</sub> =10V	t <sub>on</sub>	-	0.4	3	ms
Turn-Off		t <sub>off</sub>	-	0.4	3	ms
Output Capacitance	I <sub>F</sub> =0mA, V <sub>L</sub> =50V, f=1MHz	C <sub>OUT</sub>	-	60	-	pF
Input Characteristics						
Input Control Current to Activate <sup>2</sup>	I <sub>L</sub> =750mA	I <sub>F</sub>	-	0.15	2	mA
Input Control Current to Deactivate	-	I <sub>F</sub>	0.1	0.14	-	mA
Input Voltage Drop	I <sub>F</sub> =5mA	$V_{F}$	0.9	1.2	1.4	V
Reverse Input Current	V <sub>R</sub> =5V	I <sub>R</sub>	-	-	10	μΑ
Common Characteristics	-			•		
Capacitance, Input to Output	V <sub>IO</sub> =0V, f=1MHz	$C_{IO}$	-	1	-	pF

Measurement taken within 1 second of on-time.

For applications requiring high temperature operation (greater than 60°C) a minimum LED drive current of 4mA is recommended.



# PERFORMANCE DATA @ 25°C (Unless Otherwise Noted)\*



<sup>\*</sup>The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



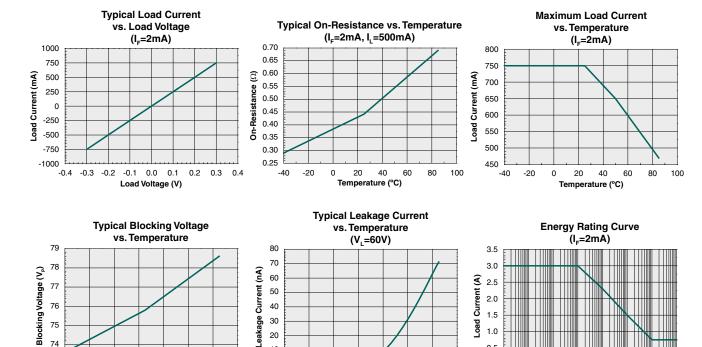
75

73

-40 -20 20 40 60 80 100

Temperature (°C)

# PERFORMANCE DATA @ 25°C (Unless Otherwise Noted)\*



40

Temperature (°C)

60 80 100

20 10

0

-40 -20 0 20 1.0

 $10\mu s$   $100\mu s$  1ms 10ms 100ms 1s

Time

10s 100s

<sup>\*</sup>The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



## **Manufacturing Information**

### **Moisture Sensitivity**

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, IPC/JEDEC J-STD-020, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC1019N	MSL 3

#### **ESD Sensitivity**



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

#### **Soldering Profile**

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time	Maximum Reflow Cycles
CPC1019N	260°C for 30 seconds	3

#### **Board Wash**

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

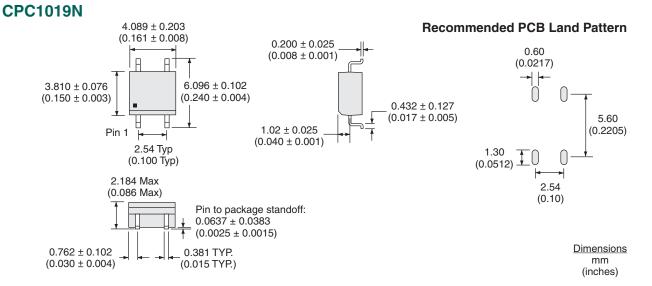




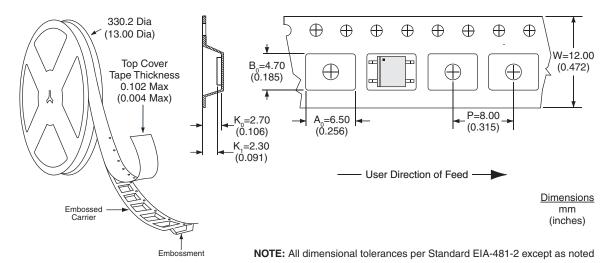




#### **MECHANICAL DIMENSIONS**



## **CPC1019NTR Tape & Reel**



#### For additional information please visit our website at: www.ixysic.com

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